

# LM2660,LM2661

*LM2660/LM2661 Switched Capacitor Voltage Converter*



Literature Number: SNVS135B

# LM2660/LM2661 Switched Capacitor Voltage Converter

## General Description

The LM2660/LM2661 CMOS charge-pump voltage converter inverts a positive voltage in the range of 1.5V to 5.5V to the corresponding negative voltage. The LM2660/LM2661 uses two low cost capacitors to provide 100 mA of output current without the cost, size, and EMI related to inductor based converters. With an operating current of only 120  $\mu$ A and operating efficiency greater than 90% at most loads, the LM2660/LM2661 provides ideal performance for battery powered systems. The LM2660/LM2661 may also be used as a positive voltage doubler.

The oscillator frequency can be lowered by adding an external capacitor to the OSC pin. Also, the OSC pin may be used to drive the LM2660/LM2661 with an external clock. For LM2660, a frequency control (FC) pin selects the oscillator frequency of 10 kHz or 80 kHz. For LM2661, an external shutdown (SD) pin replaces the FC pin. The SD pin can be used to disable the device and reduce the quiescent current to 0.5  $\mu$ A. The oscillator frequency for the LM2661 is 80 kHz.

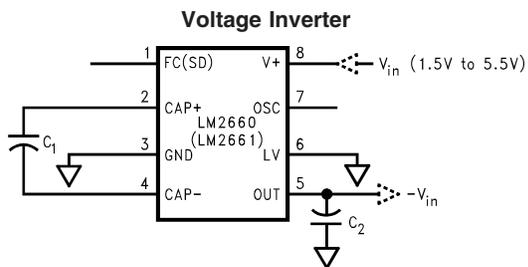
## Features

- Inverts or doubles input supply voltage
- Narrow SO-8 and Mini SO-8 Package
- 6.5 $\Omega$  typical output resistance
- 88% typical conversion efficiency at 100 mA
- (LM2660) selectable oscillator frequency: 10 kHz/80 kHz
- (LM2661) low current shutdown mode

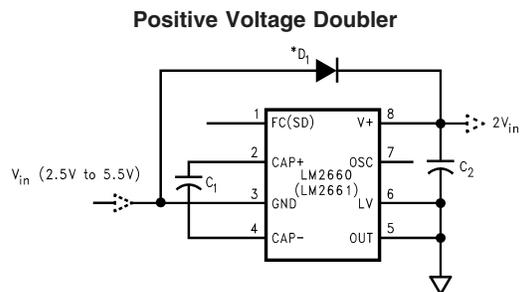
## Applications

- Laptop computers
- Cellular phones
- Medical instruments
- Operational amplifier power supplies
- Interface power supplies
- Handheld instruments

## Basic Application Circuits

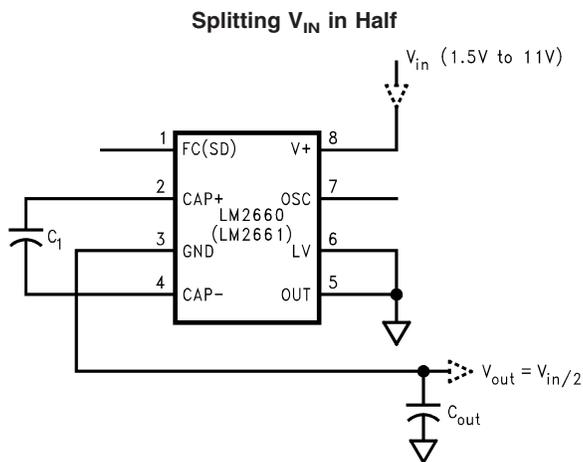


01291103



\* See Application Information for selecting D<sub>1</sub>

01291104



01291126

## Absolute Maximum Ratings (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

Supply Voltage (V+ to GND, or GND to OUT)	6V
LV	(OUT – 0.3V) to (GND + 3V)
FC, OSC	The least negative of (OUT – 0.3V) or (V+ – 6V) to (V+ + 0.3V)
V+ and OUT Continuous Output Current	120 mA
Output Short-Circuit Duration to GND (Note 2)	1 sec.

	Package	
	M	MM
Power Dissipation ( $T_A = 25^\circ\text{C}$ ) (Note 3)	735 mW	500 mW
$T_J$ Max (Note 3)	150°C	150°C
$\theta_{JA}$ (Note 3)	170°C/W	250°C/W
Operating Junction Temperature Range	–40°C to +85°C	
Storage Temperature Range	–65°C to +150°C	
Lead Temperature (Soldering, 10 seconds)	300°C	
ESD Rating	2 kV	

## Electrical Characteristics

Limits in standard typeface are for  $T_J = 25^\circ\text{C}$ , and limits in **boldface** type apply over the full operating temperature range. Unless otherwise specified: V+ = 5V, FC = Open,  $C_1 = C_2 = 150\ \mu\text{F}$ . (Note 4)

Symbol	Parameter	Condition		Min	Typ	Max	Units
V+	Supply Voltage	$R_L = 1\text{k}$	Inverter, LV = Open	<b>3.5</b>		<b>5.5</b>	V
			Inverter, LV = GND	<b>1.5</b>		<b>5.5</b>	
			Doubler, LV = OUT	<b>2.5</b>		<b>5.5</b>	
$I_Q$	Supply Current	No Load LV = Open	FC = Open (LM2660)		0.12	<b>0.5</b>	mA
			FC = V+ (LM2660) or SD = Ground (LM2661)		1	<b>3</b>	
$I_{SD}$	Shutdown Supply Current (LM2661)				0.5	<b>2</b>	$\mu\text{A}$
$V_{SD}$	Shutdown Pin Input Voltage (LM2661)	Shutdown Mode		<b>2.0</b>	(Note 5)		V
		Normal Operation				<b>0.3</b>	
$I_L$	Output Current	$T_A \leq +85^\circ\text{C}$ , OUT $\leq -4\text{V}$		<b>100</b>			mA
		$T_A > +85^\circ\text{C}$ , OUT $\leq -3.8\text{V}$		<b>100</b>			
$R_{OUT}$	Output Resistance (Note 6)	$I_L = 100\ \text{mA}$	$T_A \leq +85^\circ\text{C}$		6.5	<b>10</b>	$\Omega$
			$T_A > +85^\circ\text{C}$			<b>12</b>	
$f_{OSC}$	Oscillator Frequency (Note 7)	OSC = Open	FC = Open	<b>5</b>	10		kHz
			FC = V+	<b>40</b>	80		
$f_{SW}$	Switching Frequency (Note 8)	OSC = Open	FC = Open	<b>2.5</b>	5		kHz
			FC = V+	<b>20</b>	40		
$I_{OSC}$	OSC Input Current	FC = Open			$\pm 2$		$\mu\text{A}$
		FC = V+			$\pm 16$		
$P_{EFF}$	Power Efficiency	$R_L$ (1k) between V+ and OUT		<b>96</b>	98		%
		$R_L$ (500) between GND and OUT		<b>92</b>	96		
		$I_L = 100\ \text{mA}$ to GND			88		
$V_{OEFF}$	Voltage Conversion Efficiency	No Load		<b>99</b>	99.96		%

**Note 1:** Absolute maximum ratings indicate limits beyond which damage to the device may occur. Electrical specifications do not apply when operating the device beyond its rated operating conditions.

**Note 2:** OUT may be shorted to GND for one second without damage. However, shorting OUT to V+ may damage the device and should be avoided. Also, for temperatures above 85°C, OUT must not be shorted to GND or V+, or device may be damaged.

**Note 3:** The maximum allowable power dissipation is calculated by using  $P_{DMAX} = (T_{JMAX} - T_A)/\theta_{JA}$ , where  $T_{JMAX}$  is the maximum junction temperature,  $T_A$  is the ambient temperature, and  $\theta_{JA}$  is the junction-to-ambient thermal resistance of the specified package.

**Note 4:** In the test circuit, capacitors  $C_1$  and  $C_2$  are 0.2 $\Omega$  maximum ESR capacitors. Capacitors with higher ESR will increase output resistance, reduce output voltage and efficiency.

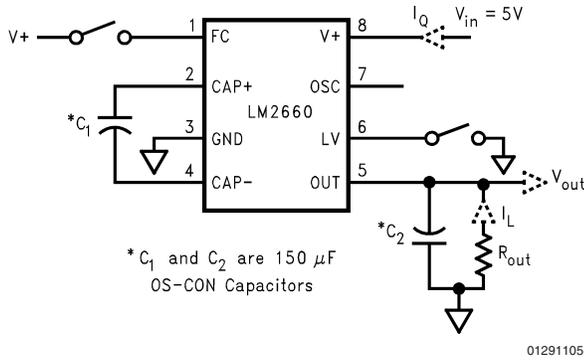
**Note 5:** In doubling mode, when  $V_{out} > 5\text{V}$ , minimum input high for shutdown equals  $V_{out} - 3\text{V}$ .

**Note 6:** Specified output resistance includes internal switch resistance and capacitor ESR.

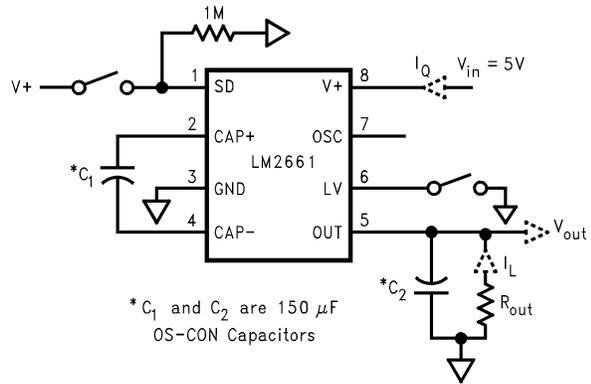
**Note 7:** For LM2661, the oscillator frequency is 80 kHz.

**Note 8:** The output switches operate at one half of the oscillator frequency,  $f_{OSC} = 2f_{SW}$ .

## Test Circuits



01291105



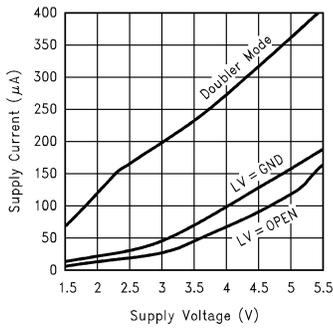
01291106

FIGURE 1. LM2660 and LM2661 Test Circuits

## Typical Performance Characteristics

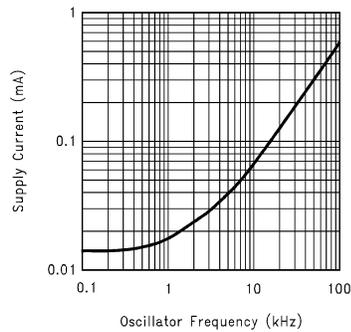
(Circuit of Figure 1)

Supply Current vs Supply Voltage



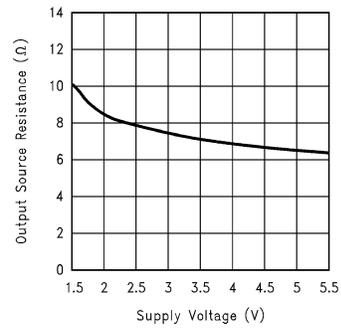
01291107

Supply Current vs Oscillator Frequency



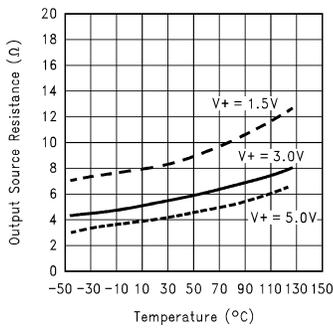
01291108

Output Source Resistance vs Supply Voltage



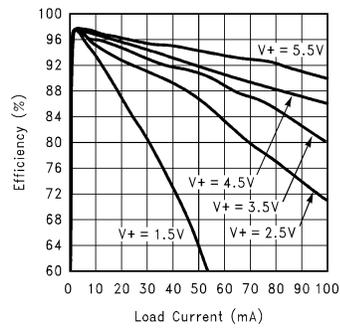
01291109

Output Source Resistance vs Temperature



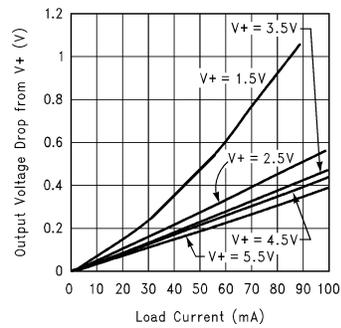
01291110

Efficiency vs Load Current



01291111

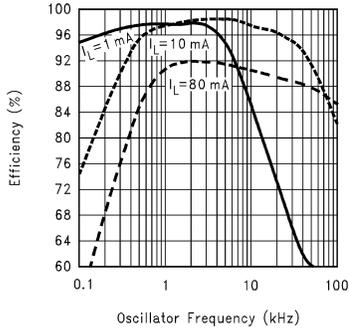
Output Voltage Drop vs Load Current



01291112

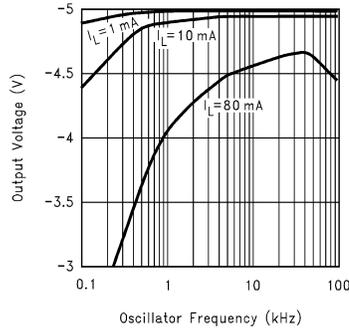
**Typical Performance Characteristics** (Circuit of Figure 1) (Continued)

**Efficiency vs Oscillator Frequency**



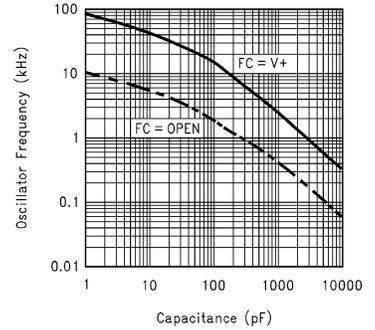
01291113

**Output Voltage vs Oscillator Frequency**



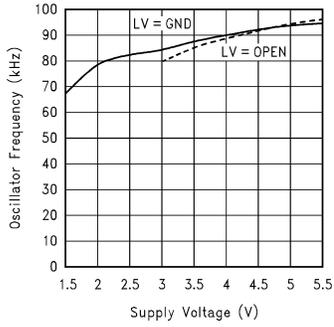
01291114

**Oscillator Frequency vs External Capacitance**



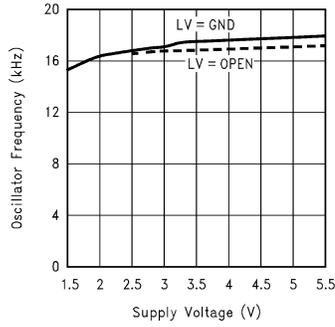
01291115

**Oscillator Frequency vs Supply Voltage (FC = V+)**



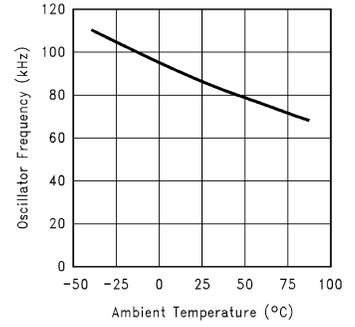
01291116

**Oscillator Frequency vs Supply Voltage (FC = Open)**



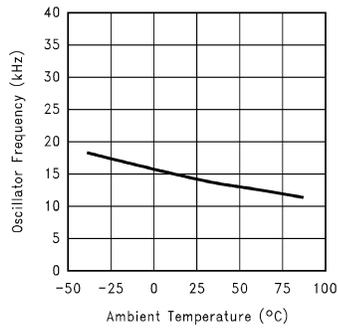
01291117

**Oscillator Frequency vs Temperature (FC = V+)**



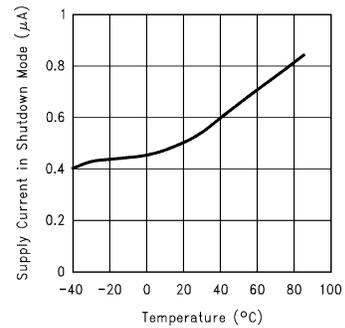
01291118

**Oscillator Frequency vs Temperature (FC = Open)**



01291119

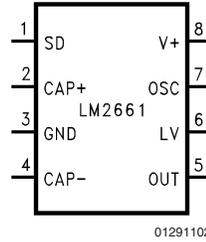
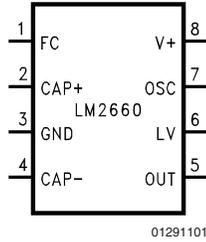
**Shutdown Supply Current vs Temperature (LM2661 Only)**



01291120

## Connection Diagrams

### 8-Lead SO (M) or Mini SO (MM)



#### Top View

Order Number LM2660M, LM2661M, LM2660MM or LM2661MM  
See NS Package Number M08A and MUA08A

## Ordering Information

Order Number	Package Number	Package Marking	Supplied As
LM2660M	M08A	Datecode LM26 60M	Rail (95 units/rail)
LM2660MX	M08A	Datecode LM26 60M	Tape and Reel (2500 units/rail)
LM2660MM	MUA08A	S01A (Note 9)	Tape and Reel (250 units/rail)
LM2660MMX	MUA08A	S01A (Note 9)	Tape and Reel (3500 units/rail)
LM2661M	M08A	Datecode LM26 61M	Rail (95 units/rail)
LM2661MX	M08A	Datecode LM26 61M	Tape and Reel (2500 units/rail)
LM2661MM	MUA08A	S02A (Note 9)	Tape and Reel (250 units/rail)
LM2661MMX	MUA08A	S02A (Note 9)	Tape and Reel (3500 units/rail)

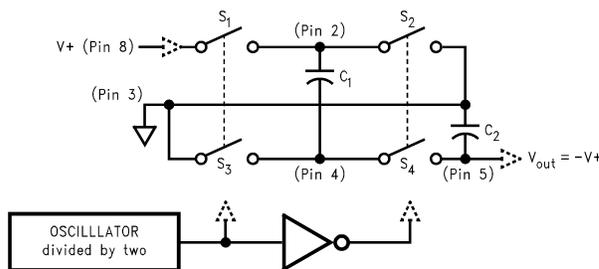
**Note 9:** The first letter "S" identifies the part as a switched capacitor converter. The next two numbers are the device number: "01" for a LM2660 device, and "02" for a LM2661 device. The fourth letter "A" indicates the grade. Only one grade is available. Larger quantity reels are available upon request.

## Pin Description

Pin	Name	Function	
		Voltage Inverter	Voltage Doubler
1	FC (LM2660)	Frequency control for internal oscillator: FC = open, $f_{OSC} = 10 \text{ kHz}$ (typ); FC = V+, $f_{OSC} = 80 \text{ kHz}$ (typ); FC has no effect when OSC pin is driven externally.	Same as inverter.
1	SD (LM2661)	Shutdown control pin, tie this pin to the ground in normal operation, and to V+ for shutdown.	Same as inverter.
2	CAP+	Connect this pin to the positive terminal of charge-pump capacitor.	Same as inverter.
3	GND	Power supply ground input.	Power supply positive voltage input.
4	CAP-	Connect this pin to the negative terminal of charge-pump capacitor.	Same as inverter.
5	OUT	Negative voltage output.	Power supply ground input.
6	LV	Low-voltage operation input. Tie LV to GND when input voltage is less than 3.5V. Above 3.5V, LV can be connected to GND or left open. When driving OSC with an external clock, LV must be connected to GND.	LV must be tied to OUT.
7	OSC	Oscillator control input. OSC is connected to an internal 15 pF capacitor. An external capacitor can be connected to slow the oscillator. Also, an external clock can be used to drive OSC.	Same as inverter except that OSC cannot be driven by an external clock.
8	V+	Power supply positive voltage input.	Positive voltage output.

## Circuit Description

The LM2660/LM2661 contains four large CMOS switches which are switched in a sequence to invert the input supply voltage. Energy transfer and storage are provided by external capacitors. Figure 2 illustrates the voltage conversion scheme. When  $S_1$  and  $S_3$  are closed,  $C_1$  charges to the supply voltage  $V_+$ . During this time interval switches  $S_2$  and  $S_4$  are open. In the second time interval,  $S_1$  and  $S_3$  are open and  $S_2$  and  $S_4$  are closed,  $C_1$  is charging  $C_2$ . After a number of cycles, the voltage across  $C_2$  will be pumped to  $V_+$ . Since the anode of  $C_2$  is connected to ground, the output at the cathode of  $C_2$  equals  $-(V_+)$  assuming no load on  $C_2$ , no loss in the switches, and no ESR in the capacitors. In reality, the charge transfer efficiency depends on the switching frequency, the on-resistance of the switches, and the ESR of the capacitors.



01291121

FIGURE 2. Voltage Inverting Principle

## Application Information

### SIMPLE NEGATIVE VOLTAGE CONVERTER

The main application of LM2660/LM2661 is to generate a negative supply voltage. The voltage inverter circuit uses only two external capacitors as shown in the Basic Application Circuits. The range of the input supply voltage is 1.5V to 5.5V. For a supply voltage less than 3.5V, the LV pin must be connected to ground to bypass the internal regulator circuitry. This gives the best performance in low voltage applications. If the supply voltage is greater than 3.5V, LV may be connected to ground or left open. The choice of leaving LV open simplifies the direct substitution of the LM2660/LM2661 for the LMC7660 Switched Capacitor Voltage Converter.

The output characteristics of this circuit can be approximated by an ideal voltage source in series with a resistor. The voltage source equals  $-(V_+)$ . The output resistance  $R_{out}$  is a function of the ON resistance of the internal MOS switches, the oscillator frequency, and the capacitance and ESR of  $C_1$  and  $C_2$ . A good approximation is:

$$R_{out} \cong 2R_{SW} + \frac{2}{f_{osc} \times C_1} + 4ESR_{C1} + ESR_{C2}$$

where  $R_{SW}$  is the sum of the ON resistance of the internal MOS switches shown in Figure 2.

High value, low ESR capacitors will reduce the output resistance. Instead of increasing the capacitance, the oscillator frequency can be increased to reduce the  $2/(f_{osc} \times C_1)$  term. Once this term is trivial compared with  $R_{SW}$  and ESRs, further increasing in oscillator frequency and capacitance will become ineffective.

## Application Information (Continued)

The peak-to-peak output voltage ripple is determined by the oscillator frequency, and the capacitance and ESR of the output capacitor  $C_2$ :

$$V_{ripple} = \frac{I_L}{f_{osc} \times C_2} + 2 \times I_L \times ESR_{C_2}$$

Again, using a low ESR capacitor will result in lower ripple.

### POSITIVE VOLTAGE DOUBLER

The LM2660/LM2661 can operate as a positive voltage doubler (as shown in the Basic Application Circuits). The doubling function is achieved by reversing some of the connections to the device. The input voltage is applied to the GND pin with an allowable voltage from 2.5V to 5.5V. The V+ pin is used as the output. The LV pin and OUT pin must be connected to ground. The OSC pin can not be driven by an external clock in this operation mode. The unloaded output voltage is twice of the input voltage and is not reduced by the diode  $D_1$ 's forward drop.

The Schottky diode  $D_1$  is only needed for start-up. The internal oscillator circuit uses the V+ pin and the LV pin (connected to ground in the voltage doubler circuit) as its power rails. Voltage across V+ and LV must be larger than 1.5V to insure the operation of the oscillator. During start-up,  $D_1$  is used to charge up the voltage at V+ pin to start the oscillator; also, it protects the device from turning-on its own parasitic diode and potentially latching-up. Therefore, the Schottky diode  $D_1$  should have enough current carrying capability to charge the output capacitor at start-up, as well as a low forward voltage to prevent the internal parasitic diode from turning-on. A Schottky diode like 1N5817 can be used for most applications. If the input voltage ramp is less than 10V/ms, a smaller Schottky diode like MBR0520LT1 can be used to reduce the circuit size.

### SPLIT V+ IN HALF

Another interesting application shown in the Basic Application Circuits is using the LM2660/LM2661 as a precision voltage divider. Since the off-voltage across each switch equals  $V_{IN}/2$ , the input voltage can be raised to +11V.

### CHANGING OSCILLATOR FREQUENCY

For the LM2660, the internal oscillator frequency can be selected using the Frequency Control (FC) pin. When FC is open, the oscillator frequency is 10 kHz; when FC is connected to V+, the frequency increases to 80 kHz. A higher oscillator frequency allows smaller capacitors to be used for equivalent output resistance and ripple, but increases the typical supply current from 0.12 mA to 1 mA.

The oscillator frequency can be lowered by adding an external capacitor between OSC and GND. (See Typical Performance Characteristics.) Also, in the inverter mode, an external clock that swings within 100 mV of V+ and GND can be used to drive OSC. Any CMOS logic gate is suitable for driving OSC. LV must be grounded when driving OSC. The maximum external clock frequency is limited to 150 kHz.

The switching frequency of the converter (also called the charge pump frequency) is half of the oscillator frequency.

**Note:** OSC cannot be driven by an external clock in the voltage-doubling mode.

TABLE 1. LM2660 Oscillator Frequency Selection

FC	OSC	Oscillator
Open	Open	10 kHz
V+	Open	80 kHz
Open or V+	External Capacitor	See Typical Performance Characteristics
N/A	External Clock (inverter mode only)	External Clock Frequency

TABLE 2. LM2661 Oscillator Frequency Selection

OSC	Oscillator
Open	80 kHz
External Capacitor	See Typical Performance Characteristics
External Clock (inverter mode only)	External Clock Frequency

### SHUTDOWN MODE

For the LM2661, a shutdown (SD) pin is available to disable the device and reduce the quiescent current to 0.5  $\mu$ A. Applying a voltage greater than 2V to the SD pin will bring the device into shutdown mode. While in normal operating mode, the SD pin is connected to ground.

### CAPACITOR SELECTION

As discussed in the *Simple Negative Voltage Converter* section, the output resistance and ripple voltage are dependent on the capacitance and ESR values of the external capacitors. The output voltage drop is the load current times the output resistance, and the power efficiency is

$$\eta = \frac{P_{out}}{P_{in}} = \frac{I_L^2 R_L}{I_L^2 R_L + I_L^2 R_{out} + I_Q (V+)}$$

Where  $I_Q(V+)$  is the quiescent power loss of the IC device, and  $I_L^2 R_{OUT}$  is the conversion loss associated with the switch on-resistance, the two external capacitors and their ESRs.

Since the switching current charging and discharging  $C_1$  is approximately twice as the output current, the effect of the ESR of the pumping capacitor  $C_1$  is multiplied by four in the output resistance. The output capacitor  $C_2$  is charging and discharging at a current approximately equal to the output current, therefore, its ESR only counts once in the output resistance. However, the ESR of  $C_2$  directly affects the output voltage ripple. Therefore, low ESR capacitors (*Table 3*) are recommended for both capacitors to maximize efficiency, reduce the output voltage drop and voltage ripple. For convenience,  $C_1$  and  $C_2$  are usually chosen to be the same.

The output resistance varies with the oscillator frequency and the capacitors. In *Figure 3*, the output resistance vs. oscillator frequency curves are drawn for three different tantalum capacitors. At very low frequency range, capacitance plays the most important role in determining the output resistance. Once the frequency is increased to some point (such as 20 kHz for the 150  $\mu$ F capacitors), the output resistance is dominated by the ON resistance of the internal switches and the ESRs of the external capacitors. A low

## Application Information (Continued)

value, smaller size capacitor usually has a higher ESR com-

pared with a bigger size capacitor of the same type. For lower ESR, use ceramic capacitors.

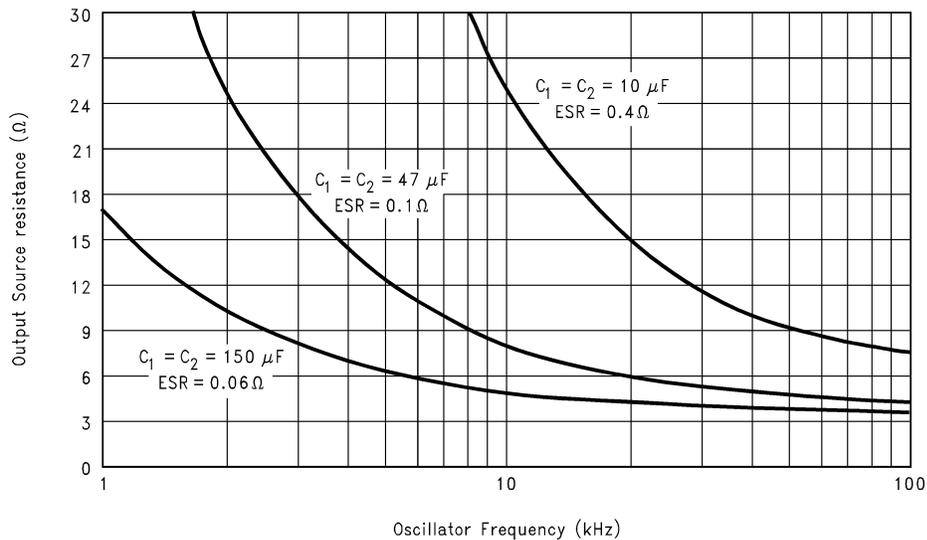


FIGURE 3. Output Source Resistance vs Oscillator Frequency

TABLE 3. Low ESR Capacitor Manufacturers

Manufacturer	Phone	FAX	Capacitor Type
Nichicon Corp.	(708)-843-7500	(708)-843-2798	PL, PF series, through-hole aluminum electrolytic
AVX Corp.	(803)-448-9411	(803)-448-1943	TPS series, surface-mount tantalum
Sprague	(207)-324-4140	(207)-324-7223	593D, 594D, 595D series, surface-mount tantalum
Sanyo	(619)-661-6835	(619)-661-1055	OS-CON series, through-hole aluminum electrolytic

## Other Applications

### PARALLELING DEVICES

Any number of LM2660s (or LM2661s) can be paralleled to reduce the output resistance. Each device must have its own pumping capacitor  $C_1$ , while only one output capacitor  $C_{out}$  is needed as shown in Figure 4. The composite output resistance is:

$$R_{out} = \frac{R_{out} \text{ of each LM2660 (or LM2661)}}{\text{Number of Devices}}$$

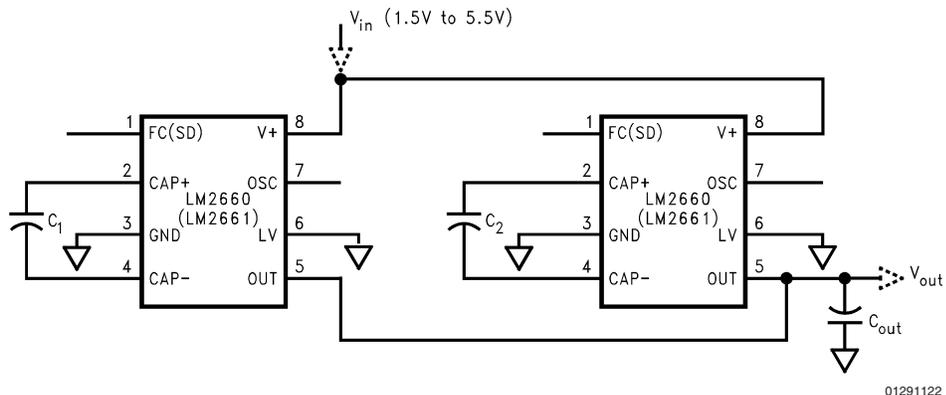


FIGURE 4. Lowering Output Resistance by Paralleling Devices

## Other Applications (Continued)

### CASCADING DEVICES

Cascading the LM2660s (or LM2661s) is an easy way to produce a greater negative voltage (as shown in *Figure 5*). If  $n$  is the integer representing the number of devices cascaded, the unloaded output voltage  $V_{out}$  is  $(-nV_{in})$ . The effective output resistance is equal to the weighted sum of each individual device:

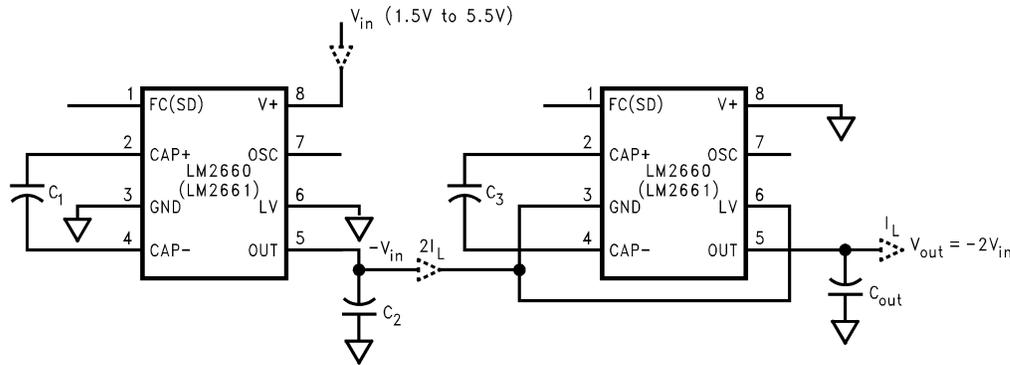
$$R_{out} = nR_{out\_1} + \frac{n}{2}R_{out\_2} + \dots + R_{out\_n}$$

A three-stage cascade circuit shown in *Figure 6* generates  $-3V_{in}$  from  $V_{in}$ .

Cascading is also possible when devices are operating in doubling mode. In *Figure 7*, two devices are cascaded to generate  $3V_{in}$ .

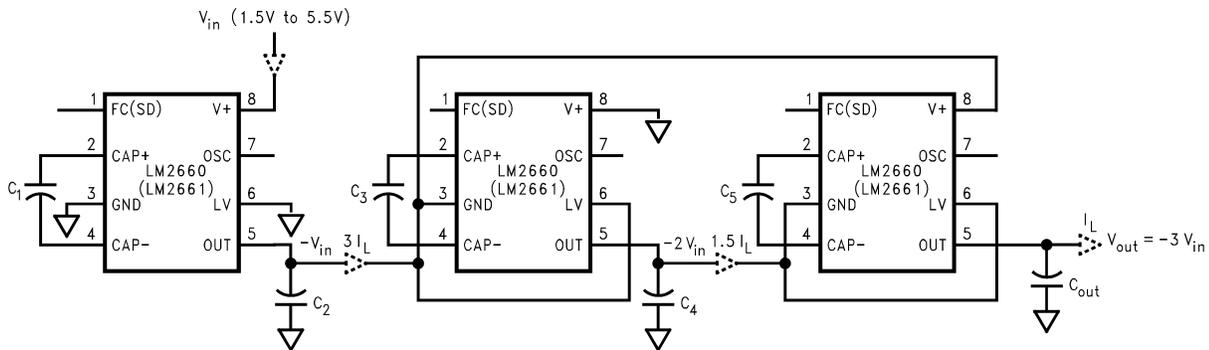
An example of using the circuit in *Figure 6* or *Figure 7* is generating  $+15V$  or  $-15V$  from a  $+5V$  input.

Note that, the number of  $n$  is practically limited since the increasing of  $n$  significantly reduces the efficiency and increases the output resistance and output voltage ripple.



01291123

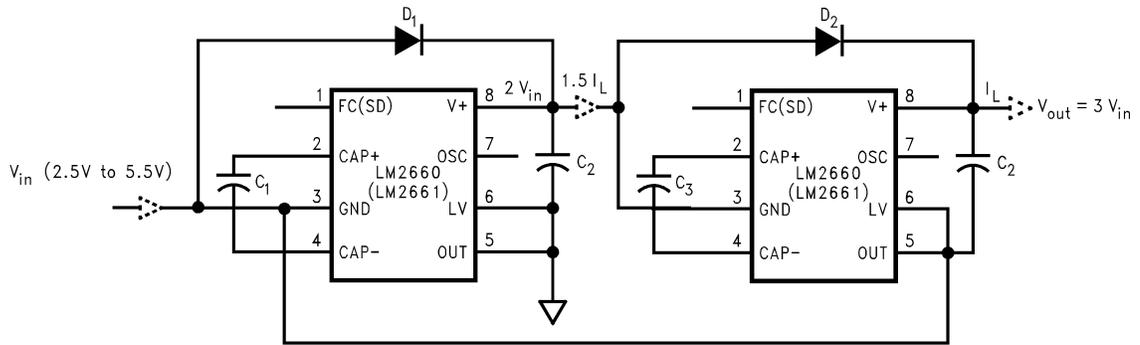
FIGURE 5. Increasing Output Voltage by Cascading Devices



01291124

FIGURE 6. Generating  $-3V_{in}$  from  $+V_{in}$

## Other Applications (Continued)



01291125

FIGURE 7. Generating  $+3V_{in}$  from  $+V_{in}$

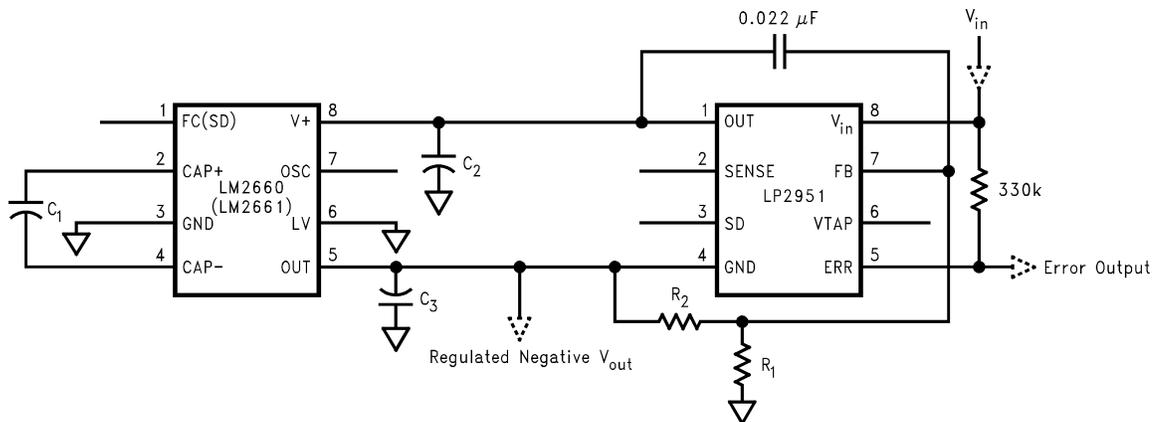
### REGULATING $V_{out}$

It is possible to regulate the output of the LM2660/LM2661 by use of a low dropout regulator (such as LP2951). The whole converter is depicted in Figure 8. This converter can give a regulated output from  $-1.5V$  to  $-5.5V$  by choosing the proper resistor ratio:

$$V_{out} = V_{ref} \left( 1 + \frac{R_1}{R_2} \right)$$

where,  $V_{ref} = 1.235V$

The error flag on pin 5 of the LP2951 goes low when the regulated output at pin 4 drops by about 5%. The LP2951 can be shutdown by taking pin 3 high.

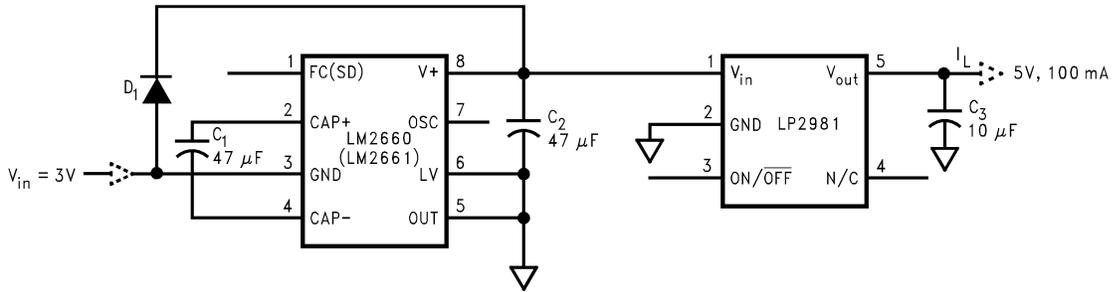


01291127

FIGURE 8. Combining LM2660/LM2661 with LP2951 to Make a Negative Adjustable Regulator

Also, as shown in Figure 9 by operating LM2660/LM2661 in voltage doubling mode and adding a linear regulator (such as LP2981) at the output, we can get  $+5V$  output from an input as low as  $+3V$ .

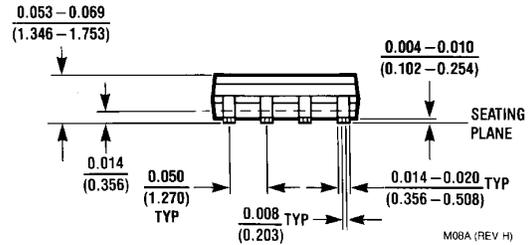
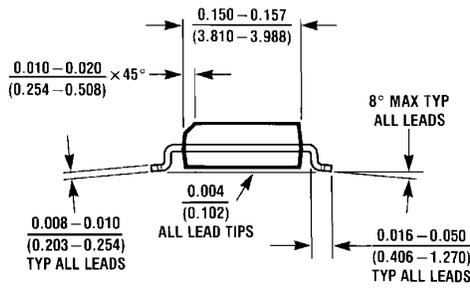
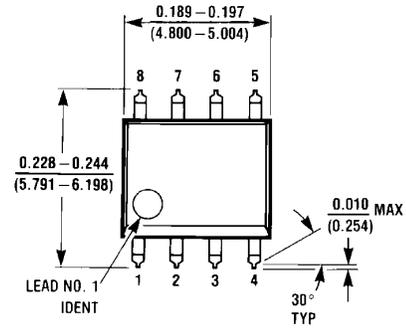
**Other Applications** (Continued)



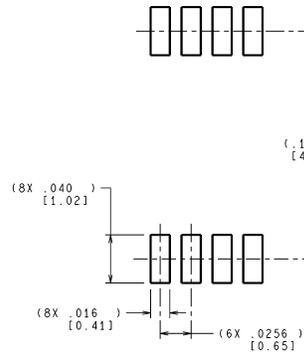
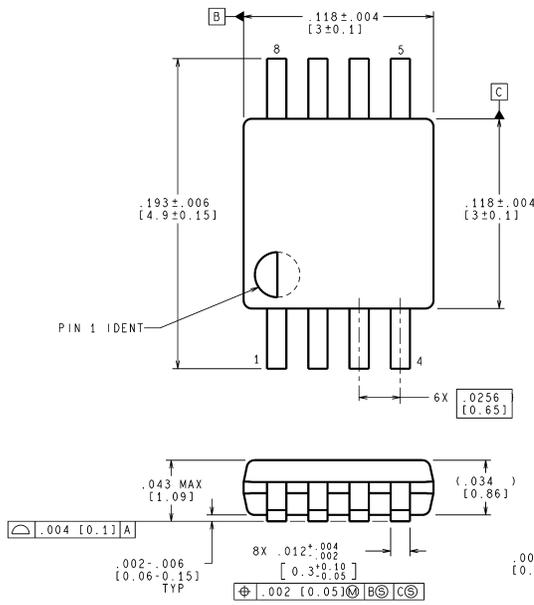
01291128

**FIGURE 9. Generating +5V from +3V Input Voltage**

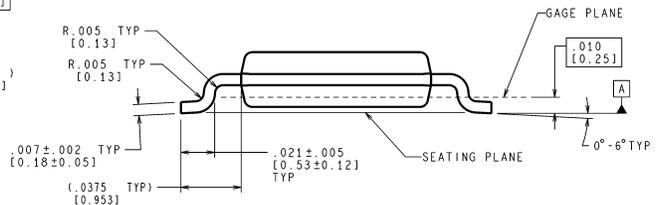
**Physical Dimensions** inches (millimeters) unless otherwise noted



**8-Lead SO (M)**  
**Order Number LM2660M or LM2661M**  
**NS Package Number M08A**



**LAND PATTERN RECOMMENDATION**



CONTROLLING DIMENSION IS INCH  
 VALUES IN [ ] ARE MILLIMETERS

MUA08A (Rev E)

**8-Lead Mini SO (MM)**  
**Order Number LM2660MM or LM2661MM**  
**NS Package Number MUA08A**

## Notes

National does not assume any responsibility for use of any circuitry described, no circuit patent licenses are implied and National reserves the right at any time without notice to change said circuitry and specifications.

For the most current product information visit us at [www.national.com](http://www.national.com).

### LIFE SUPPORT POLICY

NATIONAL'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF THE PRESIDENT AND GENERAL COUNSEL OF NATIONAL SEMICONDUCTOR CORPORATION. As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury to the user.
2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

### BANNED SUBSTANCE COMPLIANCE

National Semiconductor certifies that the products and packing materials meet the provisions of the Customer Products Stewardship Specification (CSP-9-111C2) and the Banned Substances and Materials of Interest Specification (CSP-9-111S2) and contain no "Banned Substances" as defined in CSP-9-111S2.



**National Semiconductor**  
**Americas Customer**  
**Support Center**  
 Email: [new.feedback@nsc.com](mailto:new.feedback@nsc.com)  
 Tel: 1-800-272-9959

**National Semiconductor**  
**Europe Customer Support Center**  
 Fax: +49 (0) 180-530 85 86  
 Email: [europe.support@nsc.com](mailto:europe.support@nsc.com)  
 Deutsch Tel: +49 (0) 69 9508 6208  
 English Tel: +44 (0) 870 24 0 2171  
 Français Tel: +33 (0) 1 41 91 8790

**National Semiconductor**  
**Asia Pacific Customer**  
**Support Center**  
 Email: [ap.support@nsc.com](mailto:ap.support@nsc.com)

**National Semiconductor**  
**Japan Customer Support Center**  
 Fax: 81-3-5639-7507  
 Email: [jpn.feedback@nsc.com](mailto:jpn.feedback@nsc.com)  
 Tel: 81-3-5639-7560

## IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

TI products are not authorized for use in safety-critical applications (such as life support) where a failure of the TI product would reasonably be expected to cause severe personal injury or death, unless officers of the parties have executed an agreement specifically governing such use. Buyers represent that they have all necessary expertise in the safety and regulatory ramifications of their applications, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of TI products in such safety-critical applications, notwithstanding any applications-related information or support that may be provided by TI. Further, Buyers must fully indemnify TI and its representatives against any damages arising out of the use of TI products in such safety-critical applications.

TI products are neither designed nor intended for use in military/aerospace applications or environments unless the TI products are specifically designated by TI as military-grade or "enhanced plastic." Only products designated by TI as military-grade meet military specifications. Buyers acknowledge and agree that any such use of TI products which TI has not designated as military-grade is solely at the Buyer's risk, and that they are solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI products are neither designed nor intended for use in automotive applications or environments unless the specific TI products are designated by TI as compliant with ISO/TS 16949 requirements. Buyers acknowledge and agree that, if they use any non-designated products in automotive applications, TI will not be responsible for any failure to meet such requirements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

### Products

Audio	<a href="http://www.ti.com/audio">www.ti.com/audio</a>
Amplifiers	<a href="http://amplifier.ti.com">amplifier.ti.com</a>
Data Converters	<a href="http://dataconverter.ti.com">dataconverter.ti.com</a>
DLP® Products	<a href="http://www.dlp.com">www.dlp.com</a>
DSP	<a href="http://dsp.ti.com">dsp.ti.com</a>
Clocks and Timers	<a href="http://www.ti.com/clocks">www.ti.com/clocks</a>
Interface	<a href="http://interface.ti.com">interface.ti.com</a>
Logic	<a href="http://logic.ti.com">logic.ti.com</a>
Power Mgmt	<a href="http://power.ti.com">power.ti.com</a>
Microcontrollers	<a href="http://microcontroller.ti.com">microcontroller.ti.com</a>
RFID	<a href="http://www.ti-rfid.com">www.ti-rfid.com</a>
OMAP Mobile Processors	<a href="http://www.ti.com/omap">www.ti.com/omap</a>
Wireless Connectivity	<a href="http://www.ti.com/wirelessconnectivity">www.ti.com/wirelessconnectivity</a>

### Applications

Communications and Telecom	<a href="http://www.ti.com/communications">www.ti.com/communications</a>
Computers and Peripherals	<a href="http://www.ti.com/computers">www.ti.com/computers</a>
Consumer Electronics	<a href="http://www.ti.com/consumer-apps">www.ti.com/consumer-apps</a>
Energy and Lighting	<a href="http://www.ti.com/energy">www.ti.com/energy</a>
Industrial	<a href="http://www.ti.com/industrial">www.ti.com/industrial</a>
Medical	<a href="http://www.ti.com/medical">www.ti.com/medical</a>
Security	<a href="http://www.ti.com/security">www.ti.com/security</a>
Space, Avionics and Defense	<a href="http://www.ti.com/space-avionics-defense">www.ti.com/space-avionics-defense</a>
Transportation and Automotive	<a href="http://www.ti.com/automotive">www.ti.com/automotive</a>
Video and Imaging	<a href="http://www.ti.com/video">www.ti.com/video</a>

TI E2E Community Home Page

[e2e.ti.com](http://e2e.ti.com)

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265  
Copyright © 2011, Texas Instruments Incorporated